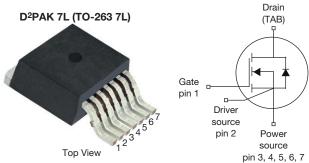


## MaxSiC® 1200 V N-Channel SiC MOSFET



Marking Code: 120A045SE

#### • F

· Fast switching speed

**FEATURES** 

• Short circuit withstand time 3 µs





#### **APPLICATIONS**

- Solar inverters
- · Energy storage systems
- UPS (uninterruptible power supplies)

PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	12	00
R <sub>DS(on)</sub> typ. (mΩ) at 25 °C	V <sub>GS</sub> = 18 V	45
Q <sub>g</sub> typ. (nC)	8	2
I <sub>D</sub> (A)	5	2
C <sub>oss</sub> typ. (pF)	9	1
P <sub>D</sub> (W)	26	88
Configuration	Sin	gle

ORDERING INFORMATION	
Package	D <sup>2</sup> PAK 7L (TO-263 7L)
Lead (Pb)-free and halogen-free	MXP120A045SE-T1GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	1200		
Gate-source voltage		V <sub>GS</sub>	-10 / +22	V	
Recommended operation voltage of gate-source		$V_{GSOP}$	-5 to -3 / +18		
Continuous drain current	T <sub>C</sub> = 25 °C	I <sub>D</sub>	52	^	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	104	Α	
Short-circuit withstand time <sup>b</sup>		T <sub>SC</sub>	3	μs	
Maximum power dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	268	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature)	For 10 s		260	°C	
Single pulse avalanche energy <sup>c</sup>		E <sub>AS</sub>	200	mJ	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{GS}$  = 18 V,  $V_{DS}$  = 800 V,  $R_{g(ext)}$  = 20  $\Omega$ , verified by the design / characterization
- c.  $T_J = 25$  °C,  $V_{DD} = 120$  V, L = 1 mH,  $V_{GS} = 18$  V,  $I_{AS} = 20$  A



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# Vishay MaxPower Semiconductor

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	-	42	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.56	C/VV

PARAMETER	SYMBOL	TEST CONDIT	TONS	MIN.	TYP.	MAX.	UNIT
Static	-					ı	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D =$	1 mA	1200			V
Cata source threshold voltage (N)	V	$V_{DS} = V_{GS}, I_D =$	5 mA	-	2.8	-	V
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 5$ mA,	T <sub>J</sub> = 175 °C	-	1.9	-	V
Cata agurag lagkaga	1	$V_{GS} = 22 \text{ V}, V_{DS}$	s = 0 V	-	-	100	nA
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = -10 \text{ V}, V_{D}$	<sub>S</sub> = 0 V	-	-	-100	IIA
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 1200 \text{ V}, V_{C}$	<sub>3S</sub> = 0 V	-	-	10	μΑ
		$V_{GS} = 15 \text{ V}, I_D = 15 \text{ V}$	= 26 A	-	60	75	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 18 \text{ V}, I_D = 10 \text{ V}$	= 26 A	-	45	56	mΩ
		$V_{GS} = 18 \text{ V}, I_D = 26 \text{ A}$	, T <sub>J</sub> = 175 °C	-	82	-	
Transconductance	gfs	$V_{DS} = 10 \text{ V}, I_D = 10 \text{ V}$	= 26 A	-	10	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>			-	2483	-	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$	/, f = 100 KHz	-	91	-	pF
Reverse transfer capacitance	C <sub>rss</sub>			-	3	-	
Total gate charge	Qg			-	82	=.	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = -5 \text{ V} \sim 18 \text{ V}, I_D = 26$	$SA, V_{DS} = 800 V$	-	25	-	nC
Gate-drain charge	$Q_{gd}$	7		-	22	-	
Gate Resistance	$R_g$	V <sub>DS</sub> = 0 V, f = 1 MHz		-	3	=.	Ω
Switching Characteristics							
Turn on dolou timo	+		T <sub>J</sub> = 25 °C	-	23	-	
Turn-on delay time	t <sub>d(on)</sub>		T <sub>J</sub> = 175 °C	-	22	-	
Diag time			T <sub>J</sub> = 25 °C	-	12	-	
Rise time	t <sub>r</sub>		T <sub>J</sub> = 175 °C	-	11	-	
Turn off delevations	1		T <sub>J</sub> = 25 °C	-	25	-	ns -
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS} = -5 \text{ V} \sim 18 \text{ V},$	T <sub>J</sub> = 175 °C	-	27	-	
Fall time	+	$I_D = 26 \text{ A}, V_{DS} = 800 \text{ V},$ $R_{q(ext)} = 4.4 \Omega$	T <sub>J</sub> = 25 °C	-	10	-	
raii tiirie	t <sub>f</sub>	g(oxt)	T <sub>J</sub> = 175 °C	-	10	=.	
Turn on quitables anarry	E <sub>on</sub>	]	T <sub>J</sub> = 25 °C	-	273	-	- μJ
Turn-on switching energy			T <sub>J</sub> = 175 °C	-	261	-	
<b>—</b> "	-		T <sub>J</sub> = 25 °C	-	74	-	
Turn-off switching energy	E <sub>off</sub>		T <sub>J</sub> = 175 °C	-	73	-	
<b>Body Diode Ratings and Characteristic</b>	C						
Forward diode voltage	V <sub>SD</sub>	V <sub>GS</sub> = -5 V, I <sub>SD</sub> = 13 A, T <sub>J</sub> = 25 °C		-	4.9	-	V
Continuous diode forward current	I <sub>SD</sub>	V 5V T 05 00		-	-	38	
Pulsed diode forward current	I <sub>SDM</sub>	$V_{GS} = -5 \text{ V}, T_{J} =$	: 25 °C	-	-	104	Α
Reverse recovery time	t <sub>rr</sub>			-	19	-	ns
Reverse recovery charge	Q <sub>rr</sub>	$V_{GS} = -5 \text{ V}, I_{SD} = -5 \text{ V}$		-	83	-	nC
Reverse recovery current	I <sub>RRM</sub>	$V_R = 800 \text{ V, di/dt} =$	τυυυ Α/μs	-	7	-	Α

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

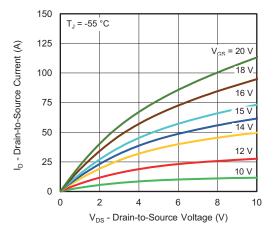


Fig. 1 - Typical Output Characteristics

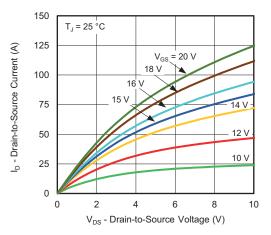


Fig. 2 - Typical Output Characteristics

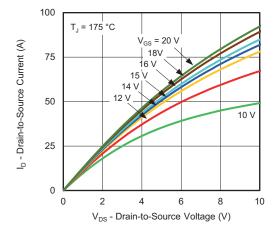


Fig. 3 - Typical Output Characteristics

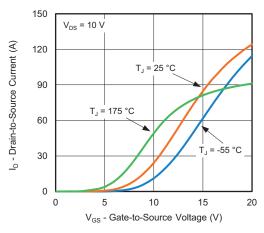


Fig. 4 - Typical Transfer Characteristics

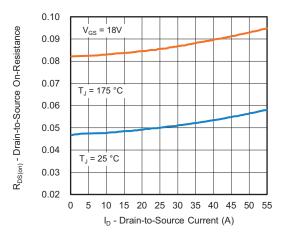


Fig. 5 - Normalized On-Resistance vs. Drain Current

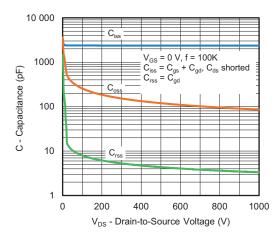


Fig. 6 - Typical Capacitance vs. Drain-to-Source Voltage



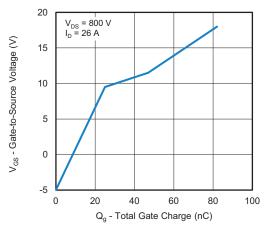


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

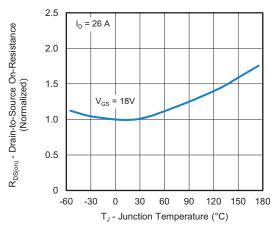


Fig. 8 - Normalized On-Resistance vs. Temperature

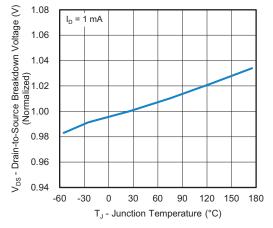


Fig. 9 - Drain-to-Source Voltage vs. Temperature

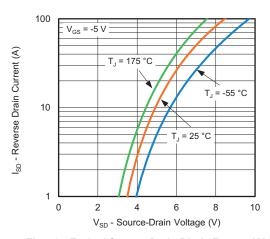


Fig. 10 - Typical Source-Drain Diode Forward Voltage

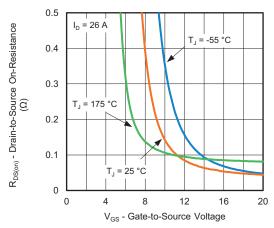


Fig. 11 - On-Resistance vs. Gate-to-Source Voltage

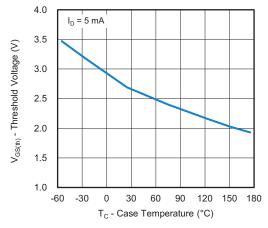


Fig. 12 - Threshold Voltage vs. Case Temperature

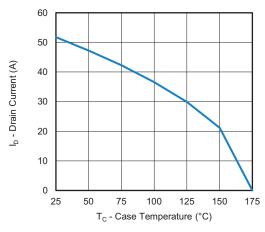


Fig. 13 - Drain Current vs. Case Temperature

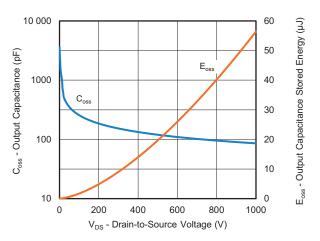


Fig. 14 - Output Capacitance and its Stored Energy vs.

Drain-to-Source Voltage

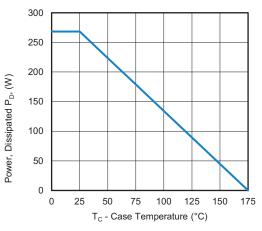


Fig. 15 - Power, Dissipated P<sub>D</sub> vs. Case Temperature

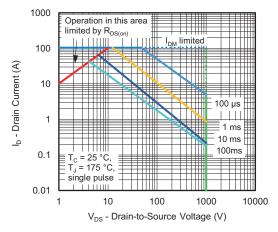


Fig. 16 - Safe Operating Area

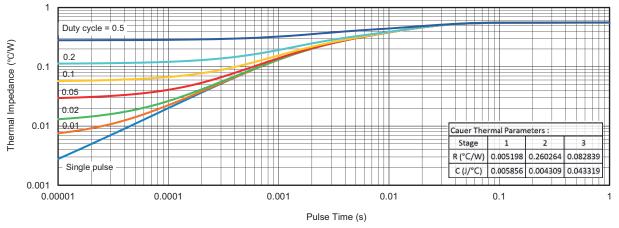


Fig. 17 - Transient Thermal Impedance



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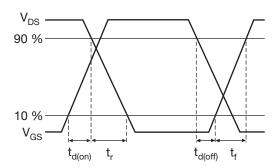


Fig. 18 - Waveforms of Switching Time

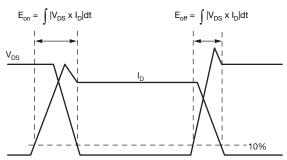


Fig. 19 - Waveforms for Switching Energy

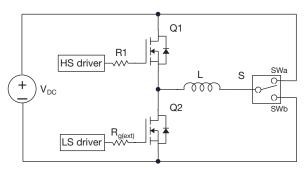


Fig. 20 - Switching and Reverse Diode Characteristics Measurement Circuit

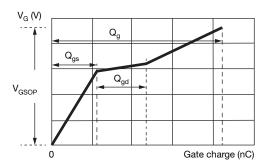


Fig. 21 - Waveforms for Gate Charge

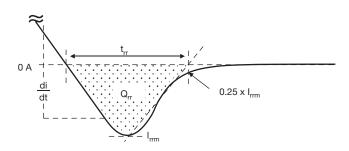


Fig. 22 - Waveforms for Reverse Recovery

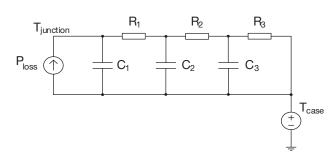


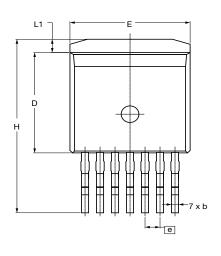
Fig. 23 - Thermal Equivalent Circuit

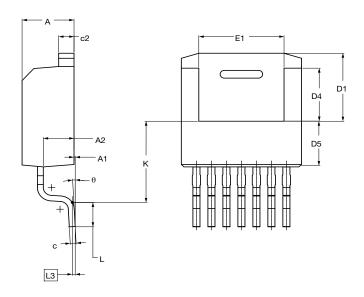
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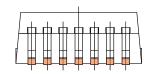


## Case Outline for TO-263 7L Package

#### **FACILITY CODE: 9**







Exposed Cu

DIM.		MILLIMETERS	
	MIN.	NOM.	MAX.
Α	4.30	4.40	4.50
A1	0.00	0.10	0.25
A2	2.45	2.60	2.75
b	0.50	0.60	0.70
С	0.45	0.50	0.60
c2	1.20	1.30	1.40
D	8.93	9.08	9.23
D1	6.15 ref.		
D4	4.65	4.80	4.95
D5	3.83	4.13	4.43
E	10.08	10.18	10.28
E1	6.82	7.22	7.62
е	1.27 BSC.		
Н	15.00	15.70	16.00
K	7.30		
L	1.90	2.20	2.50
L1	1.00	1.20	1.40
L3	0.25 BSC.		
θ	0 °	3 °	7 °

#### ECN: S25-0851-Rev. C, 18-Jul-2025

#### Notes

DWG: 6119

- All dimensions are in mm and angles are in degrees
  Dimension D and E do not include mold flash. These dimensions are measured at the outermost extreme of the plastic body
  Thermal pad contour optional within Dimensions E, L1, D4 and E1
- Dimension D4 and E1 establish a minimum mounting surface for the thermal pad
- There is exposed Cu and molding flash bleeding at the pin which is close to package



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